

#### **FEATURES**

- Member of the Texas Instruments Widebus™
   Family
- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t<sub>pd</sub> of 4.2 ns at 3.3 V
- Typical V<sub>OLP</sub> (Output Ground Bounce)
   <0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)
   >2 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V<sub>CC</sub>)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

#### 48 20E 10E [ 1Y1 2 47 1A1 1Y2 I 3 GND 4 45 GND 1Y3 🛮 5 44 🛮 1A3 1Y4 6 43 1A4 42 V<sub>CC</sub> $V_{CC}$ 2Y1 8 41 ∏ 2A1 2Y2 9 40 2A2 GND [] 10 39 GND 2Y3 [] 11 38 2A3 2Y4 | 12 37 | 2A4 3Y1 13 36∏ 3A1 3Y2 14 35 3A2 GND 15 34 GND 3Y3 1 16 33 T 3A3 3Y4 **1** 17 32 T 3A4

31 V<sub>CC</sub>

30 4A1

29 4A2

28 GND

27 AA3

26 4A4

25 3OE

V<sub>CC</sub> 18

4Y1 119

4Y2 20

GND I 21

4Y3 🛮 22

4Y4 🛮 23

DGG OR DL PACKAGE

(TOP VIEW)

# **DESCRIPTION/ORDERING INFORMATION**

This 16-bit buffer/driver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

The SN74LVCH16240A is designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

The device can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. This device provides inverting outputs and symmetrical active-low output-enable (OE) inputs.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

#### ORDERING INFORMATION

| T <sub>A</sub> | PACK        | AGE <sup>(1)</sup> | ORDERABLE PART NUMBER | TOP-SIDE MARKING |  |  |
|----------------|-------------|--------------------|-----------------------|------------------|--|--|
|                | SSOP – DL   | Tube               | SN74LVCH16240ADL      | 1.1/01/462404    |  |  |
| –40°C to 85°C  | 220b – DF   | Tape and reel      | SN74LVCH16240ADLR     | LVCH16240A       |  |  |
|                | TSSOP - DGG | Tape and reel      | SN74LVCH16240ADGGR    | LVCH16240A       |  |  |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments.



# **DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

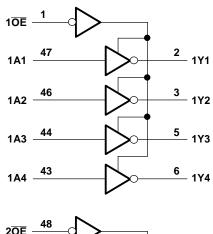
Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

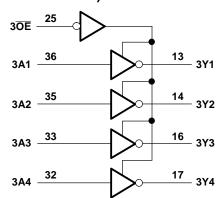
This device is fully specified for partial-power-down applications using  $I_{\text{off}}$ . The  $I_{\text{off}}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

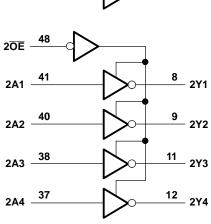
# FUNCTION TABLE (EACH 4-BIT BUFFER)

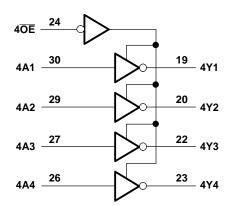
| INP | UTS | OUTPUT |
|-----|-----|--------|
| ŌĒ  | Α   | Y      |
| L   | Н   | L      |
| L   | L   | Н      |
| Н   | Χ   | Z      |

### **LOGIC DIAGRAM (POSITIVE LOGIC)**











# Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |   |                    | MIN                   | MAX  | UNIT |  |
|------------------|---|--------------------|-----------------------|------|------|--|
| V <sub>CC</sub>  | Supply voltage range  |                    | -0.5                  | 6.5  | V    |  |
| VI               | Input voltage range (2)   | -0.5               | 6.5                   | V    |      |  |
| Vo               | Voltage range applied to any output in the high-impedance o     | -0.5               | 6.5                   | V    |      |  |
| Vo               | Voltage range applied to any output in the high or low state (2 | -0.5               | V <sub>CC</sub> + 0.5 | V    |      |  |
| I <sub>IK</sub>  | Input clamp current   | V <sub>I</sub> < 0 |                       | -50  | mA   |  |
| I <sub>OK</sub>  | Output clamp current  | V <sub>O</sub> < 0 |                       | -50  | mA   |  |
| Io               | Continuous output current                                       |                    |                       | ±50  | mA   |  |
|                  | Continuous current through each V <sub>CC</sub> or GND          |                    |                       | ±100 | mA   |  |
| 0                | Deckage thermal impedance (4)                                   | DGG package        | 70                    |      | °C/W |  |
| $\theta_{JA}$    | Package thermal impedance (4)                                   | DL package         |                       | 63   | C/VV |  |
| T <sub>stg</sub> | Storage temperature range                                       |                    | -65                   | 150  | °C   |  |

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

### Recommended Operating Conditions<sup>(1)</sup>

|                 |                                    |  | MIN                  | MAX                  | UNIT |  |  |  |
|-----------------|------------------------------------|--|----------------------|----------------------|------|--|--|--|
| V               | Cumply voltage                     | Operating                                  | 1.65                 | 3.6                  | V    |  |  |  |
| $V_{CC}$        | Supply voltage                     | Data retention only                        | 1.5                  |                      | _ V  |  |  |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V to 1.95 V         | $0.65 \times V_{CC}$ |                      |      |  |  |  |
| $V_{IH}$        | High-level input voltage           | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.7                  |                      | V    |  |  |  |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V           | 2                    |                      |      |  |  |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V to 1.95 V         |                      | $0.35 \times V_{CC}$ |      |  |  |  |
| $V_{IL}$        | Low-level input voltage            | V <sub>CC</sub> = 2.3 V to 2.7 V           |                      | 0.7                  | V    |  |  |  |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V           |                      | 0.8                  |      |  |  |  |
| VI              | Input voltage                      |  | 0                    | 5.5                  | V    |  |  |  |
| .,              | Output walks as                    | High or low state                          | 0                    | V <sub>CC</sub>      | V    |  |  |  |
| $V_{O}$         | Output voltage                     | 3-state                                    | 0                    | 5.5                  | V    |  |  |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V                   |                      | -4                   |      |  |  |  |
|                 | High level eviterat evinent        | V <sub>CC</sub> = 2.3 V                    |                      | -8                   | 4    |  |  |  |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 2.7 V                    |                      | -12                  | mA   |  |  |  |
|                 |                                    | V <sub>CC</sub> = 3 V                      |                      | -24                  |      |  |  |  |
|                 |                                    | V <sub>CC</sub> = 1.65 V                   |                      | 4                    |      |  |  |  |
|                 | Lavidaval autout avenue            | V <sub>CC</sub> = 2.3 V                    |                      | 8                    | Л    |  |  |  |
| l <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 2.7 V                    |                      | 12                   | mA   |  |  |  |
|                 |                                    | V <sub>CC</sub> = 3 V                      |                      | 24                   | 24   |  |  |  |
| Δt/Δν           | Input transition rise or fall rate | ,  |                      | 10                   | ns/V |  |  |  |
| T <sub>A</sub>  | Operating free-air temperature     |  | -40                  | 85                   | °C   |  |  |  |

<sup>(1)</sup> All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

The value of V<sub>CC</sub> is provided in the recommended operating conditions table.

<sup>(4)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

SCAS566H-MARCH 1996-REVISED MARCH 2005



#### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        | TEST CONDITIONS   | V <sub>cc</sub> | MIN                   | TYP <sup>(1)</sup> MAX | UNIT |
|------------------|---|-----------------|-----------------------|------------------------|------|
|                  | I <sub>OH</sub> = -100 μA                                       | 1.65 V to 3.6 V | V <sub>CC</sub> - 0.2 |                        |      |
|                  | $I_{OH} = -4 \text{ mA}$  | 1.65 V          | 1.2                   |                        |      |
| V                | $I_{OH} = -8 \text{ mA}$  | 2.3 V           | 1.7                   |                        |      |
| $V_{OH}$         | 1 42 m 4  | 2.7 V           | 2.2                   |                        | V    |
|                  | $I_{OH} = -12 \text{ mA}$                                       | 3 V             | 2.4                   |                        |      |
|                  | $I_{OH} = -24 \text{ mA}$                                       | 3 V             | 2.2                   |                        |      |
|                  | I <sub>OL</sub> = 100 μA  | 1.65 V to 3.6 V |                       | 0.2                    |      |
|                  | $I_{OL} = 4 \text{ mA}$   | 1.65 V          |                       | 0.45                   |      |
| $V_{OL}$         | $I_{OL} = 8 \text{ mA}$   | 2.3 V           |                       | 0.7                    | V    |
|                  | I <sub>OL</sub> = 12 mA   | 2.7 V           |                       | 0.4                    |      |
|                  | I <sub>OL</sub> = 24 mA   | 3 V             |                       | 0.55                   |      |
| l <sub>l</sub>   | V <sub>I</sub> = 0 to 5.5 V                                     | 3.6 V           |                       | ±5                     | μΑ   |
|                  | $V_{I} = 0.58 \text{ V}$  | 1.65 V          | (2)                   |                        |      |
|                  | $V_{I} = 1.07 \text{ V}$  | 1.05 V          | (2)                   |                        |      |
|                  | $V_{I} = 0.7 \text{ V}$   | 2.3 V           | 45                    |                        | μΑ   |
| $I_{I(hold)}$    | V <sub>I</sub> = 1.7 V  | 2.3 V           | -45                   |                        |      |
|                  | $V_{I} = 0.8 \text{ V}$   | 3 V             | 75                    |                        |      |
|                  | $V_I = 2 V$   | 3 V             | <b>-75</b>            |                        |      |
|                  | $V_1 = 0$ to 3.6 $V^{(3)}$                                      | 3.6 V           |                       | ±500                   |      |
| I <sub>off</sub> | $V_I$ or $V_O = 5.5 \text{ V}$                                  | 0               |                       | ±10                    | μΑ   |
| $I_{OZ}$         | $V_0 = 0 \text{ to } 5.5 \text{ V}$                             | 3.6 V           |                       | ±10                    | μΑ   |
| 1                | $V_1 = V_{CC}$ or GND $I_{CC} = 0$                              | 3.6 V           |                       | 20                     | пΔ   |
| I <sub>CC</sub>  | $3.6 \text{ V} \le \text{V}_{\text{I}} \le 5.5 \text{ V}^{(4)}$ | 3.0 v           |                       | 20                     | μΑ   |
| $\Delta I_{CC}$  | One input at $V_{CC}$ – 0.6 V, Other inputs at $V_{CC}$ or GND  | 2.7 V to 3.6 V  |                       | 500                    | μΑ   |
| $C_{i}$          | $V_I = V_{CC}$ or GND   | 3.3 V           |                       | 5                      | pF   |
| $C_o$            | $V_O = V_{CC}$ or GND   | 3.3 V           |                       | 6                      | pF   |

### **Switching Characteristics**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CC</sub> =<br>± 0.1 | 1.8 V<br>5 V | V <sub>CC</sub> = ± 0.2 | 2.5 V<br>2 V | V <sub>CC</sub> = | 2.7 V | V <sub>CC</sub> = 3<br>± 0.3 | 3.3 V<br>3 V | UNIT |
|------------------|-----------------|----------------|----------------------------|--------------|-------------------------|--------------|-------------------|-------|------------------------------|--------------|------|
|                  | (INFOT)         | (001701)       | MIN                        | MAX          | MIN                     | MAX          | MIN               | MAX   | MIN                          | MAX          |      |
| t <sub>pd</sub>  | Α               | Υ              | (1)                        | (1)          | (1)                     | (1)          |                   | 5     | 1                            | 4.2          | ns   |
| t <sub>en</sub>  | ŌĒ              | Υ              | (1)                        | (1)          | (1)                     | (1)          |                   | 5.8   | 1.5                          | 4.7          | ns   |
| t <sub>dis</sub> | ŌĒ              | Υ              | (1)                        | (1)          | (1)                     | (1)          |                   | 6.6   | 1.5                          | 5.9          | ns   |

<sup>(1)</sup> This information was not available at the time of publication.

All typical values are at V<sub>CC</sub> = 3.3 V,  $T_A$  = 25°C. This information was not available at the time of publication.

This is the bus-hold maximum dynamic current required to switch the input from one state to another.

<sup>(4)</sup> This applies in the disabled state only.





# **Operating Characteristics**

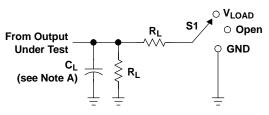
 $T_A = 25^{\circ}C$ 

|                               | PARAMETER         |                  | TEST<br>CONDITIONS | V <sub>CC</sub> = 1.8 V<br>TYP | V <sub>CC</sub> = 2.5 V<br>TYP | V <sub>CC</sub> = 3.3 V<br>TYP | UNIT |
|-------------------------------|-------------------|------------------|--------------------|--------------------------------|--------------------------------|--------------------------------|------|
| Power dissipation capacitance |                   | Outputs enabled  | f = 10 MHz         | (1)                            | (1)                            | 34                             | pF   |
| $C_{pd}$                      | per buffer/driver | Outputs disabled | I = IU IVIMZ       | (1)                            | (1)                            | 3                              | рг   |

<sup>(1)</sup> This information was not available at the time of publication.



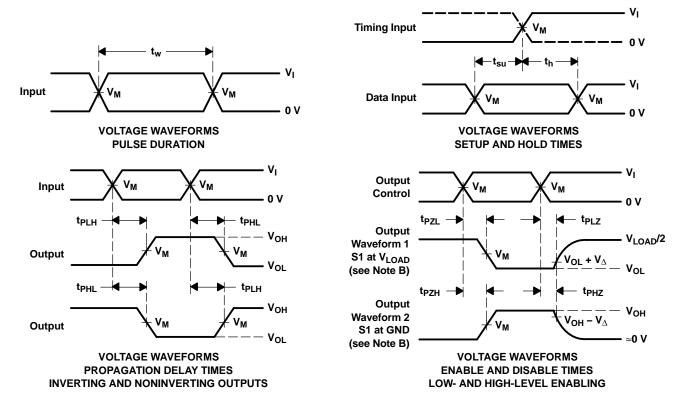
#### PARAMETER MEASUREMENT INFORMATION



| TEST                               | S1                |
|------------------------------------|-------------------|
| t <sub>PLH</sub> /t <sub>PHL</sub> | Open              |
| t <sub>PLZ</sub> /t <sub>PZL</sub> | V <sub>LOAD</sub> |
| t <sub>PHZ</sub> /t <sub>PZH</sub> | GND               |

**LOAD CIRCUIT** 

| v                 | INF             | PUTS                           | .,                 | V                 | •     |                | .,           |
|-------------------|-----------------|--------------------------------|--------------------|-------------------|-------|----------------|--------------|
| V <sub>CC</sub>   | VI              | t <sub>r</sub> /t <sub>f</sub> | V <sub>M</sub>     | V <sub>LOAD</sub> | CL    | R <sub>L</sub> | $V_{\Delta}$ |
| 1.8 V ± 0.15 V    | v <sub>cc</sub> | ≤2 ns                          | V <sub>CC</sub> /2 | 2×V <sub>CC</sub> | 30 pF | <b>1 k</b> Ω   | 0.15 V       |
| 2.5 V $\pm$ 0.2 V | V <sub>CC</sub> | ≤2 ns                          | V <sub>CC</sub> /2 | 2×V <sub>CC</sub> | 30 pF | 500 Ω          | 0.15 V       |
| 2.7 V             | 2.7 V           | ≤2.5 ns                        | 1.5 V              | 6 V               | 50 pF | 500 Ω          | 0.3 V        |
| 3.3 V $\pm$ 0.3 V | 2.7 V           | ≤2.5 ns                        | 1.5 V              | 6 V               | 50 pF | 500 Ω          | 0.3 V        |



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>O</sub> = 50 Ω.
- D. The outputs are measured one at a time, with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- G. t<sub>PLH</sub> and t<sub>PHL</sub> are the same as t<sub>pd</sub>.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



## PACKAGE OPTION ADDENDUM

10-Dec-2020

#### PACKAGING INFORMATION

| Orderable Device   | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|--------------------|--------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|-------------------------|---------|
|                    |        |              |                    |      |                |              | (6)                           |                    |              |                         |         |
| SN74LVCH16240ADGGR | ACTIVE | TSSOP        | DGG                | 48   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | LVCH16240A              | Samples |
| SN74LVCH16240ADL   | ACTIVE | SSOP         | DL                 | 48   | 25             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | LVCH16240A              | Samples |
| SN74LVCH16240ADLR  | ACTIVE | SSOP         | DL                 | 48   | 1000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -40 to 85    | LVCH16240A              | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## **PACKAGE OPTION ADDENDUM**

10-Dec-2020

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

# PACKAGE MATERIALS INFORMATION

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### TAPE AND REEL INFORMATION





| A0 | <u> </u>  |
|----|---|
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device             | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74LVCH16240ADGGR | TSSOP           | DGG                | 48 | 2000 | 330.0                    | 24.4                     | 8.6        | 13.0       | 1.8        | 12.0       | 24.0      | Q1               |
| SN74LVCH16240ADLR  | SSOP            | DL                 | 48 | 1000 | 330.0                    | 32.4                     | 11.35      | 16.2       | 3.1        | 16.0       | 32.0      | Q1               |

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#### \*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVCH16240ADGGR | TSSOP        | DGG             | 48   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74LVCH16240ADLR  | SSOP         | DL              | 48   | 1000 | 367.0       | 367.0      | 55.0        |

# PACKAGE MATERIALS INFORMATION

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### **TUBE**



#### \*All dimensions are nominal

| Device           | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74LVCH16240ADL | DL           | SSOP         | 48   | 25  | 473.7  | 14.24  | 5110   | 7.87   |

# DL (R-PDSO-G48)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.





SMALL OUTLINE PACKAGE



#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
  4. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



### DGG (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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